

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/788,449	03/01/2004	Nobuaki Hashimoto	118875	9255
25944	7590 01/12/2006		EXAM	INER
OLIFF & BE P.O. BOX 199	RRIDGE, PLC		PHAM, LONG	
	A, VA 22320		ART UNIT PAPER NUMBER	
	,		2814	

DATE MAILED: 01/12/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

			E
	Application No.	Applicant(s)	
	10/788,449	HASHIMOTO, NOBUAKI	
Office Action Summary	Examiner	Art Unit	
	Long Pham	2814	
The MAILING DATE of this communication		vith the correspondence address	
Period for Reply			
A SHORTENED STATUTORY PERIOD FOR F WHICHEVER IS LONGER, FROM THE MAILII - Extensions of time may be available under the provisions of 37 of after SIX (6) MONTHS from the mailing date of this communicat - If NO period for reply is specified above, the maximum statutory - Failure to reply within the set or extended period for reply will, by Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b).	NG DATE OF THIS COMMUN CFR 1.136(a). In no event, however, may a ion. period will apply and will expire SIX (6) MO statute, cause the application to become A	ICATION. reply be timely filed NTHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed on			
•	This action is non-final.		
3) Since this application is in condition for a	llowance except for formal ma	ters, prosecution as to the merits is	
closed in accordance with the practice ur	nder <i>Ex par</i> te <i>Quayle</i> , 1935 C.I	D. 11, 453 O.G. 213.	
Disposition of Claims			
4)⊠ Claim(s) <u>1-34</u> is/are pending in the applic	ation.		
4a) Of the above claim(s) <u>2-4,6,11-13,15</u>		m consideration.	
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1,5,7-10,14 and 16-18</u> is/are rej	ected.		
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction	and/or election requirement.		
Application Papers			
9) The specification is objected to by the Exa	aminer.		
10) The drawing(s) filed on is/are: a)		by the Examiner.	
Applicant may not request that any objection			
Replacement drawing sheet(s) including the o	correction is required if the drawing	g(s) is objected to. See 37 CFR 1.121(d).	
11)☐ The oath or declaration is objected to by t	he Examiner. Note the attache	d Office Action or form PTO-152.	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for fo	oreign priority under 35 U.S.C.	§ 119(a)-(d) or (f).	
a) ☐ All b) ☐ Some * c) ☐ None of:			
1. Certified copies of the priority docu	ments have been received.		
2. Certified copies of the priority docu	ments have been received in a	Application No	
Copies of the certified copies of the		n received in this National Stage	
application from the International E	, , , , , , , , , , , , , , , , , , , ,		
* See the attached detailed Office action for	a list of the certified copies no	; received.	
Attachment(s)			
1) ⊠ Notice of References Cited (PTO-892) 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-94		Summary (PTO-413) (s)/Mail Date	
 Notice of Draitsperson's Patent Drawing Review (P10-94) Information Disclosure Statement(s) (PTO-1449 or PTO/Paper No(s)/Mail Date 3 IDS. 	· · · /	Informal Patent Application (PTO-152)	

Application/Control Number: 10/788,449

Art Unit: 2814

DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of claims 1, 5, 7-10, 14, and 16-18 in the reply filed on 12/02/05 is acknowledged.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1, 5, 7, 8, 9, 10, 14, and 16-18 are rejected under 35 U.S.C. 103(a) as being unpatentable Nakayama et al. (US patent 6,621,172) in combination with Hirakata et al. (US patent 6,638,781).

With respect to claims 1, 9, 10, and 18, Nakayama et al. teach an electronic device comprising (see figs. 1-6 and associated text):

A substrate 70 on which an interconnect pattern 72 is formed;

A chip component 20 having a first surface on which an electrode 22,42 is formed and a second surface opposite to the first surface, the chip component being mounted in such a manner that the second surface faces the substrate;

A section (side of chip) formed of resin and provided adjacent to the chip component; and

An interconnect 26 which is formed to extend from above the electrode, over the resin section and to above the interconnect pattern.

Application/Control Number: 10/788,449

Art Unit: 2814

Nakayama et al. teach the section on the side of the chip comprises of conductive resin and conductive resin 74 between the chip and substrate but fail to teach that the resin is insulating.

Hirakata et al. teach that insulating resin is used because of its superior levelness and low dielectric constant. See col. 15, lines 5-15.

It would have been obvious to one of <u>ordinary skill</u> in the art of making semiconductor devices to incorporate the above teaching of Hirakata into the device of Nakayama et al. to achieve the above benefit.

With respect to claims 5 and 14, Nakayama et al. in combination with Hirakata et al. further teach that the insulating resin section is formed so that part of the insulating resin section does not overlay the first surface.

With respect to claims 7 and 16, Nakayama et al. further teach that a connection layer 74 that connects the chip component with the substrate. See figs 1-2.

With respect to claims 8 and 17, Nakayama et al. further teach that the connection layer is formed of the same material as the insulating resin section. See figs. 1 and 2.

With respect to claim 10, Nakayama et al. further teach the resin section has an inclined surface descending in an outward direction from the chip.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Long Pham whose telephone number is 571-272-1714. The examiner can normally be reached on Mon-Frid, 10am to 5pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on 571-272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Application/Control Number: 10/788,449 Page 4

Art Unit: 2814

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair.direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Løng Pham

Primary Examiner

Art Unit 2814

LP